1-1734099-2 ACTIVE

CHAMP | CHAMP .050 Series I

TE Internal #: 1-1734099-2

CHAMP .050 Series I, PCB Mount Header, Right Angle, Board-to-

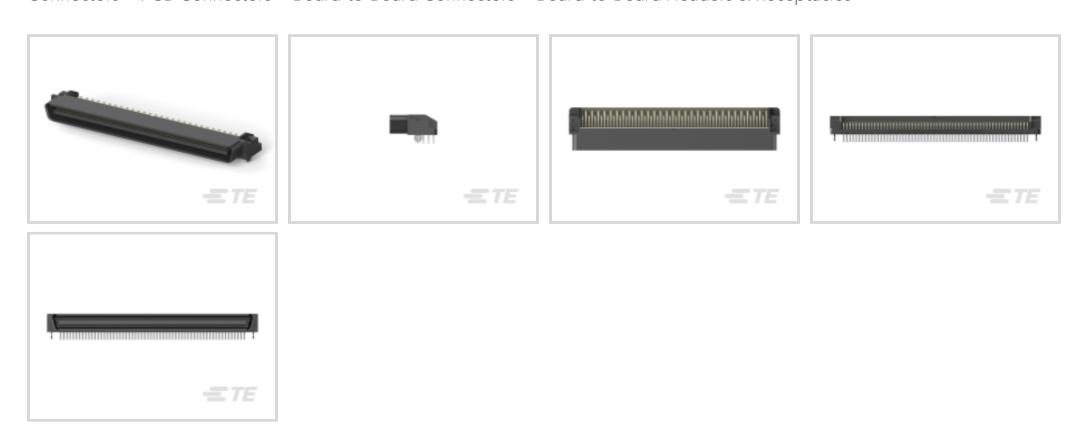
Board, 120 Position, 1.27mm [.05in] Centerline, Fully Shrouded,

Gold Flash

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Connectors > PCB Connectors > Board-to-Board Connectors > Board-to-Board Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Right Angle
Connector System: Board-to-Board

Number of Positions: 120

Centerline (Pitch): 1.27 mm [.05 in]

Features

Product Type Features

Product Type Features	
PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Rows	4
Stackable	No
PCB Mount Orientation	Right Angle
Number of Positions	120
Electrical Characteristics	
Dielectric Withstanding Voltage (Max)	500 VAC
Insulation Resistance	4 MΩ

12 VDC

Operating Voltage



Body Features

PCB Retention Feature Material	Brass
PCB Retention Feature Plating Material	Tin-Copper over Nickel
Connector Profile	Standard
Contact Features	

Contact Layout	Matrix
PCB Contact Termination Area Plating Material Thickness	3.81 μm[149.9997 μin]
Mating Tab Width	.75 mm[.03 in]
Mating Tab Thickness	.3 mm[.012 in]
PCB Contact Termination Area Plating Material Finish	Matte
Contact Shape & Form	Square
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold Flash
	1.9685 μin
Contact Type	Pin
Contact Current Rating (Max)	1 A

Termination Features

Rectangular Termination Post & Tail Thickness	.29 mm[.012 in]
Rectangular Termination Post & Tail Width	.5 mm[.02 in]
Termination Post & Tail Length	3.1 mm[.122 in]
Termination Method to Printed Circuit Board	Through Hole - Solder

Mechanical Attachment

PCB Mount Retention Type	Boardlock
Mating Alignment	With
Mating Alignment Type	Polarized
PCB Mount Retention	With
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount

Housing Features

Centerline (Pitch)	1.27 mm[.05 in]
Housing Color	Black



Housing Material	Matte
Dimensions	
Connector Height	7.5 mm[.295 in]
Stack Height	13.2 mm[.52 in]
Usage Conditions	
Operating Temperature Range	-35 – 85 °C[-31 – 185 °F]
Operation/Application	
Assembly Process Feature	None
Circuit Application	Signal
Circuit Application Industry Standards	Signal
	Signal UL 94V-0
Industry Standards	
Industry Standards UL Flammability Rating	

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2021 (211) Candidate List Declared Against: DEC 2010 (44) SVHC > Threshold: Not Yet Reviewed
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part



numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulations, TE's information on SVHC in articles for this part number is still based on the European Chemical Agency (ECHA) 'Guidance on requirements for substances in articles' (Version: 2, April 2011), applying the 0.1% weight on weight concentration threshold at the finished product level. TE is aware of the European Court of Justice ruling of September 10th, 2015 also known as O5A (Once An Article Always An Article) stating that, in case of 'complex object', the threshold for a SVHC must be applied to both the product as a whole and simultaneously to each of the articles forming part of its composition. TE has evaluated this ruling based on the new ECHA "Guidance on requirements for substances in articles" (June 2017, version 4.0) and will be updating its statements accordingly.

Compatible Parts





Also in the Series | CHAMP .050 Series |



Board-to-Board Headers & Receptacles(120)



IDC D-Sub Connectors(6)



Standard Rectangular Connectors(1)

Customers Also Bought



TE Part #1658614-1 IDC D-Sub: Receptacle Assembly, Low Profile, Signal, 2.77 mm













Champ 050 series, plug assembly









Documents

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1-1734099-2_F.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1-1734099-2_F.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1-1734099-2_F.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

Application Specification

English

CHAMP .050 High Density Connector

English

Application Specification

English